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4/22/02 Jasita C. Beall
Date Signature

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Serial No. 10/099861 Filed 3/15/02
(Attorney Docket No. DP-305031)

Inventors: SHING YEH
BRADLEY H. CARTER
CURTIS W. MELCHER

Title: LEAD-FREE SOLDER ALLOY AND SOLDER REFLOW PROCESS

Enclosed to complete this patent application is a Declaration. Please charge \$ 1284.00 filing fee
and surcharge to DELPHI TECHNOLOGIES, INC. Deposit Account No. 50-0831.

Filing Fee Formula

Basic Fee..... \$ 740.00

Additional Fees:

Number of independent claims in excess of 3, times \$84.00 \$ 0.00
Number of claims in excess of 20, times \$18.00 \$ 414.00
Multiple dependent claim (N), add \$280.00 \$ 0.00

Total Filing Fee..... \$ 1154.00

Surcharge \$ 130.00

Total \$ 1284.00

The application Serial No. 10/099861 filed 3/15/02 in the Patent and Trademark
Office is the application for which the inventor(s) executed the Declaration enclosed herewith.

Jimmy L. Funke
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Enclosures



UNITED STATES PATENT AND TRADEMARK OFFICE

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APPLICATION NUMBER	FILING/RECEIPT DATE	FIRST NAMED APPLICANT	ATTORNEY DOCKET NUMBER
10/099,861	03/15/2002	Shing Yeh	DP-305031

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CONFIRMATION NO. 4475
FORMALITIES LETTER

OC000000007877988*

Reply Due 6/17/02

Date Mailed: 04/17/2002

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

05/02/2002 AOSMAN1 00000037 500831 10099861

FILED UNDER 37 CFR 1.53(b)

01 FC:101 740.00 CH
02 FC:103 414.00 CH
03 FC:105 130.00 CH

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given **TWO MONTHS** from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The statutory basic filing fee is missing.
Applicant must submit \$ 740 to complete the basic filing fee for a non-small entity. If appropriate, applicant may make a written assertion of entitlement to small entity status and pay the small entity filing fee (37 CFR 1.27).
- Total additional claim fee(s) for this application is \$414.
■ \$414 for 23 total claims over 20.
- The oath or declaration is missing.
A properly signed oath or declaration in compliance with 37 CFR 1.63, identifying the application by the above Application Number and Filing Date, is required.
- To avoid abandonment, a late filing fee or oath or declaration surcharge as set forth in 37 CFR 1.16(l) of \$130 for a non-small entity, must be submitted with the missing items identified in this letter.
The balance due by applicant is \$ 1284.

*A copy of this notice **MUST** be returned with the reply.*

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